



STTA312B(-TR)

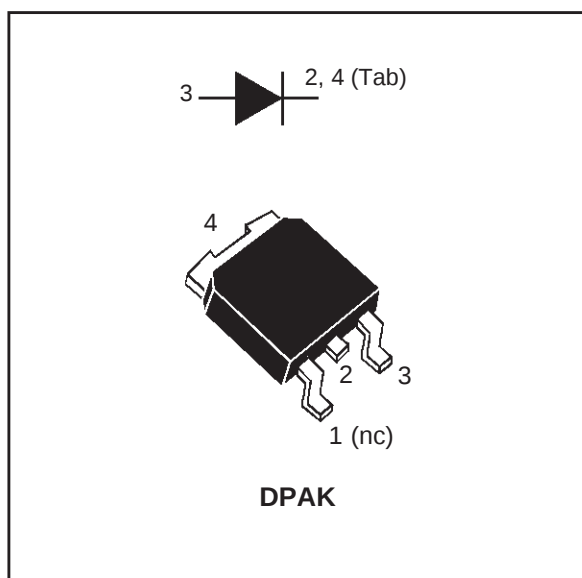
TURBOSWITCH™ "A" . ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCT CHARACTERISTICS

$I_F(AV)$	3 A
V_{RRM}	1200 V
$V_F(max)$	1.7 V
$t_{rr}(typ)$	65 ns

FEATURES AND BENEFITS

- SPECIFIC TO THE FOLLOWING OPERATIONS: SNUBBING OR CLAMPING, DEMAGNETIZATION AND RECTIFICATION
- ULTRA-FAST, VERY SOFT AND NOISE-FREE RECOVERY
- VERY LOW OVERALL POWER LOSSES AND PARTICULARLY LOW FORWARD VOLTAGE
- SURFACE MOUNT DEVICE
- TAPE AND REEL OPTION : -TR



DESCRIPTION

TURBOSWITCH 1200V drastically cuts losses in all high voltage operations which require extremely fast, soft and noise-free power diodes.

Due to their optimized switching performances they also highly decrease power losses in any associated switching IGBT or MOSFET in all "Freewheel Mode" operations.

They are particularly suitable in Motor Control circuitries, or in primary of SMPS as snubber, clamping or demagnetizing diodes, and also in at the secondary of SMPS as high voltage rectifier diodes.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		1200	V
V_{RSM}	Non repetitive surge reverse voltage		1200	V
$I_{F(RMS)}$	RMS forward current		8	A
I_{FRM}	Repetitive peak forward current	$t_p = 5 \mu s$ $F = 1 KHz$	50	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10ms$ Sine	25	A
T_{stg}	Storage temperature range		- 65 to + 150	°C
T_j	Maximum junction temperature		125	°C

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THERMAL AND POWER DATA

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance		6.5	°C/W
P_1	Conduction power dissipation	$I_{F(AV)} = 3A$, $\delta = 0.5$ $T_c = 80^\circ C$	6.7	W
P_{max}	Total power dissipation $P_{max} = P_1 + P_3$ ($P_3 = 10\% P_1$)	$T_c = 76^\circ C$	7.5	W

STATIC ELECTRICAL CHARACTERISTICS (see figure 6)

Symbol	Tests Conditions	Tests Conditions	Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$V_R = 0.8 \times V_{RRM}$	$T_j = 25^\circ C$		20	μA
			$T_j = 125^\circ C$	150	400	μA
V_F^{**}	Forward voltage drop	$I_F = 3A$	$T_j = 25^\circ C$		1.8	V
		$I_F = 3A$	$T_j = 125^\circ C$	1.15	1.7	
V_{to}	Threshold voltage	$T_j = 125^\circ C$			1.15	V
r_d	Dynamic resistance				185	m Ω

Pulse test : * $t_p = 5\text{ ms}$, $\delta < 2\%$
** $t_p = 380\text{ }\mu s$, $\delta < 2\%$

DYNAMIC ELECTRICAL CHARACTERISTICS

TURN-OFF SWITCHING (see figure 7)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{rr}		$T_j = 25^\circ C$ $I_F = 0.5A$ $I_R = 1A$ $I_{rr} = 0.25A$ $I_F = 1A$ $di_F/dt = 50A/\mu s$ $V_R = 30V$		65	115	ns
I_{RM}	Maximum recovery current	$T_j = 125^\circ C$ $I_F = 3A$ $V_R = 600V$ $di_F/dt = -16A/\mu s$ $di_F/dt = -50A/\mu s$		6.0	3.6	A
S factor	Softness factor	$T_j = 125^\circ C$ $V_R = 600V$ $I_F = 3A$ $di_F/dt = -50A/\mu s$		1.2		-

TURN-ON SWITCHING (see figure 8)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{fr}	Forward recovery time	$T_j = 25^\circ C$ $I_F = 2A$ $di_F/dt = 16A/\mu s$ Measured at $1.1 \times V_{Fmax}$			900	ns
V_{FP}	Peak forward voltage				35	V

APPLICATION DATA

The 1200V TURBOSWITCH™ series has been designed to provide the lowest overall power losses in all frequency or high pulsed current operations.

In such application (fig. 1 to 5), the way of calculating the power losses is given below :

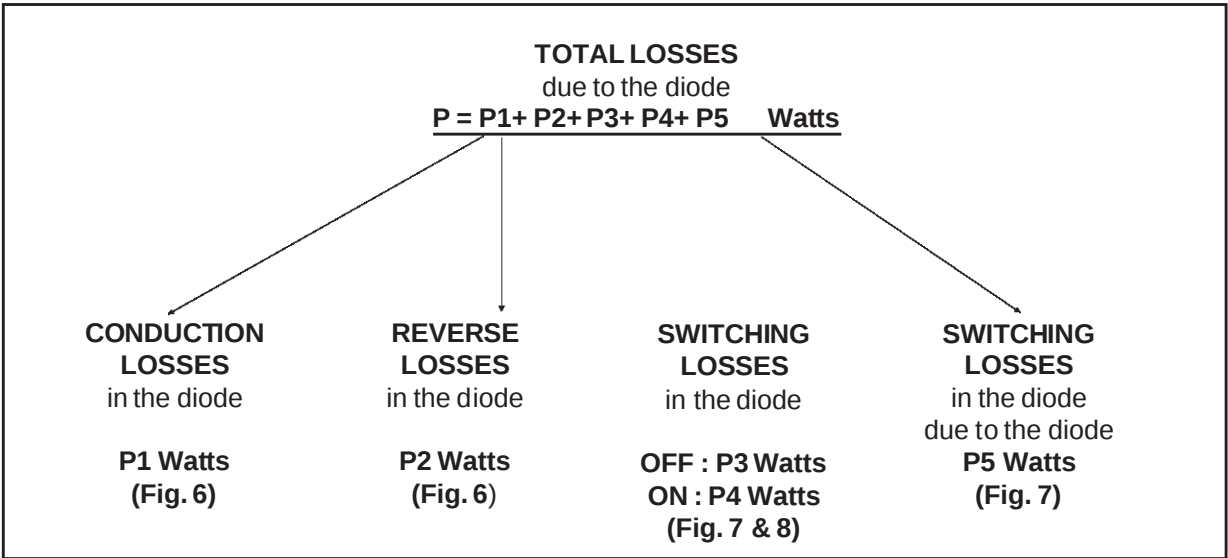
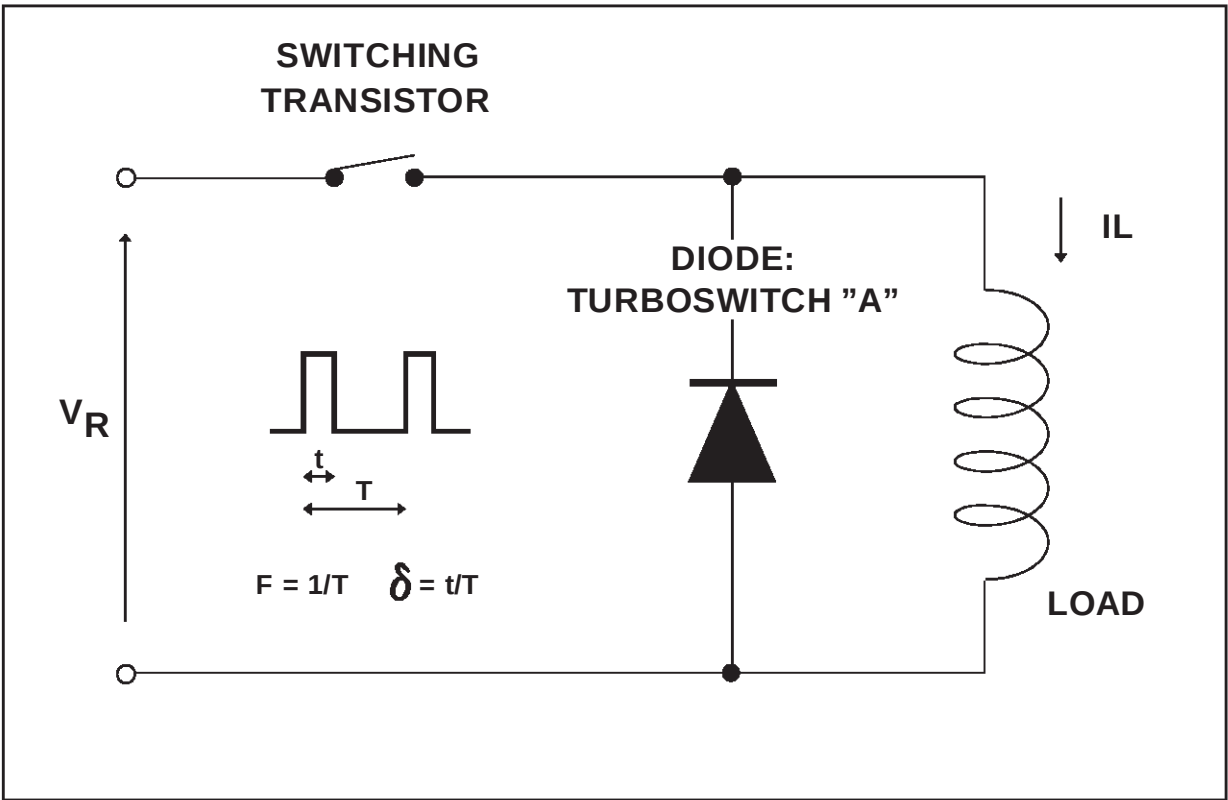


Fig. 1 : "FREEWHEEL MODE".



APPLICATION DATA (Cont'd)

Fig. 2 : SNUBBER DIODE.

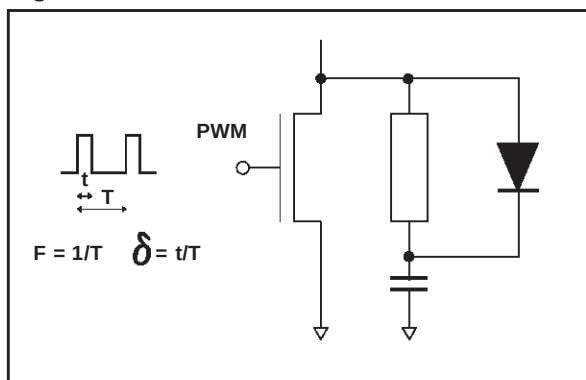


Fig. 3 : CLAMPING DIODE.

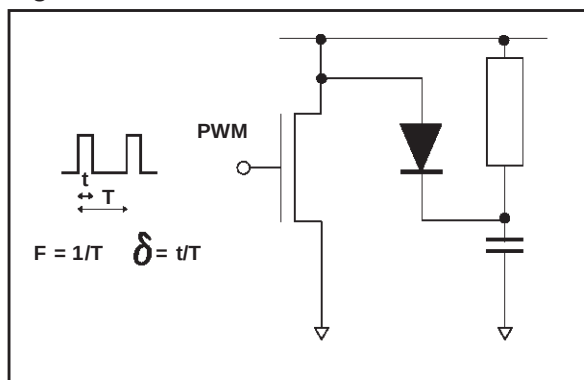


Fig. 4 : DEMAGNETIZING DIODE.

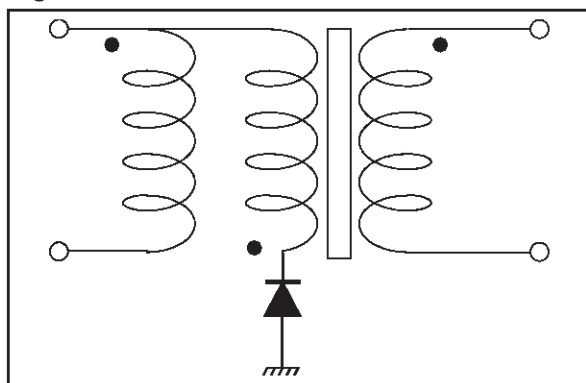


Fig. 5 : RECTIFIER DIODE.

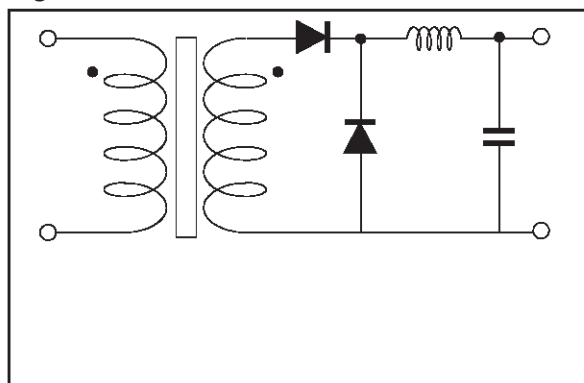
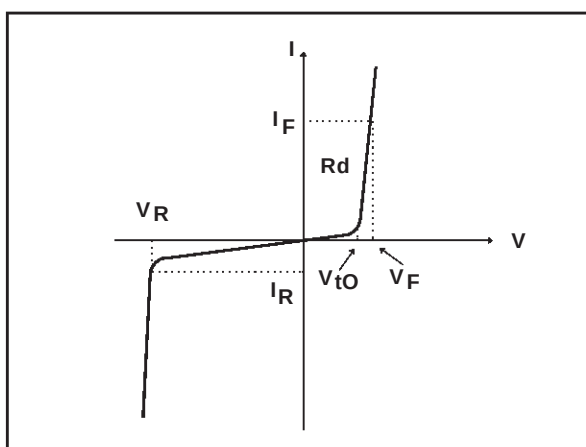


Fig. 6 : STATIC CHARACTERISTICS.



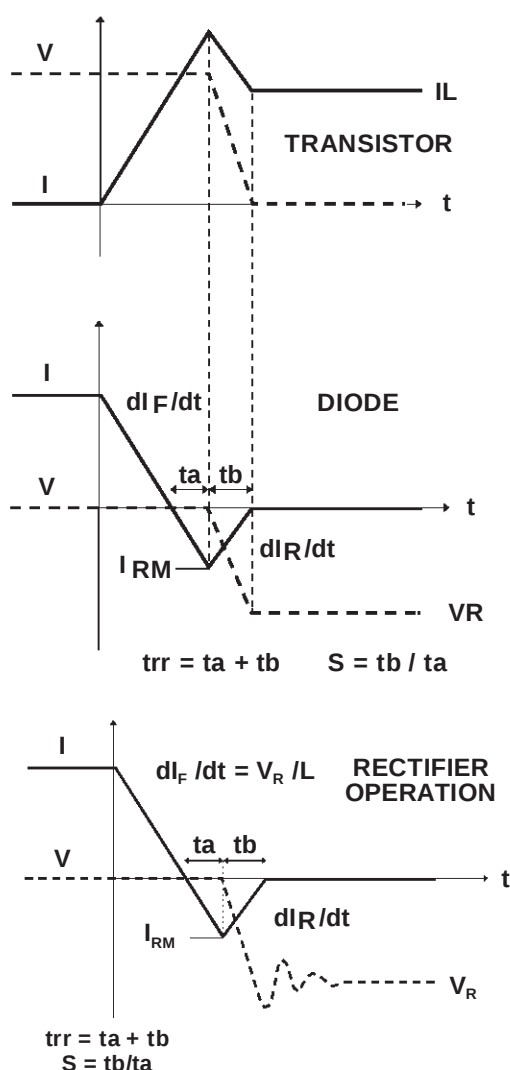
Conduction losses :

$$P1 = V_{t0} \times I_{F(AV)} + R_d \times I_F^2(RMS)$$

Reverse losses :

$$P2 = V_R \times I_R \times (1 - \delta)$$

APPLICATION DATA (Cont'd)



Turn-on losses :
(in the transistor, due to the diode)

$$P5 = \frac{V_R \times I_{RM}^2 \times (3+2 \times S) F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S+2) \times F}{2 \times dI_F/dt}$$

Turn-off losses :

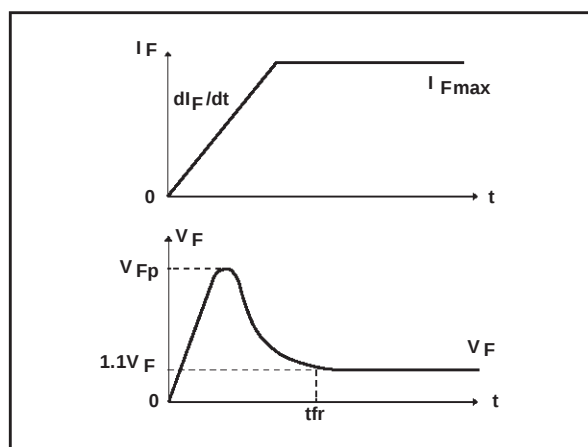
$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

Turn-off losses :
with non negligible serial inductance

$$P3' = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt} + \frac{L \times I_{RM}^2 \times F}{2}$$

P3, P3' and P5 are suitable for power MOSFET and IGBT

Fig.8 : TURN-ON CHARACTERISTICS.



Turn-on losses :
 $P4 = 0.4 (V_{FP} - V_F) \times I_{Fmax} \times t_{tr} \times F$

Ratings and characteristics curves are ON GOING.

Fig. 9: Conduction losses versus average current.

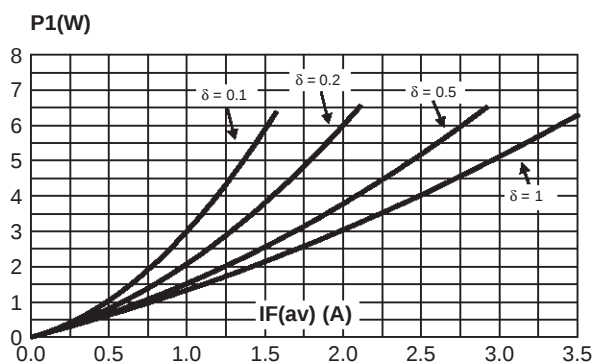


Fig. 11: Switching ON losses versus dI_F/dt .

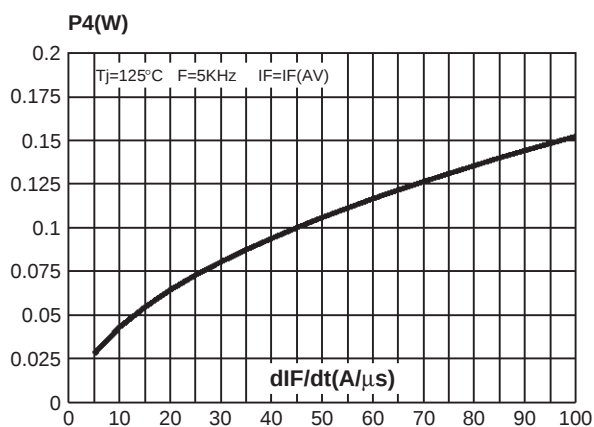


Fig. 13: Forward voltage drop versus forward current (maximum values).

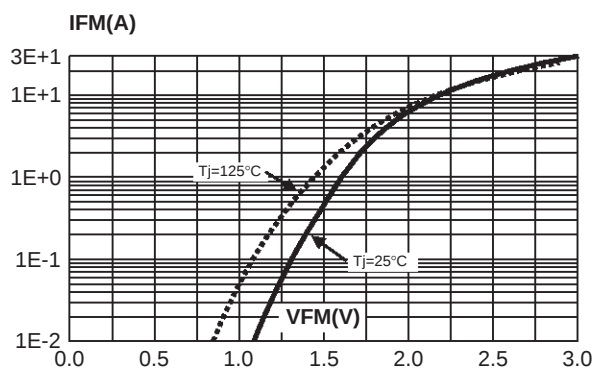


Fig. 10: Switching OFF losses versus dI_F/dt .

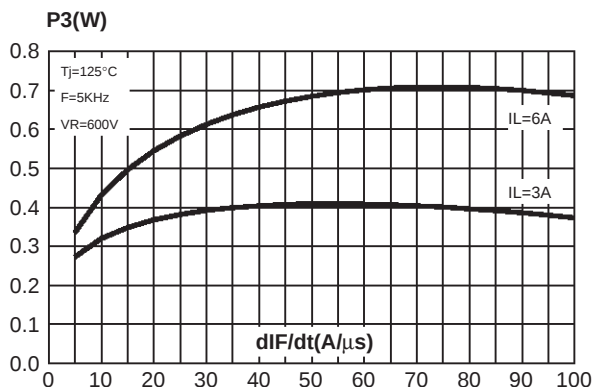


Fig. 12: Switching losses in transistor due to the diode.

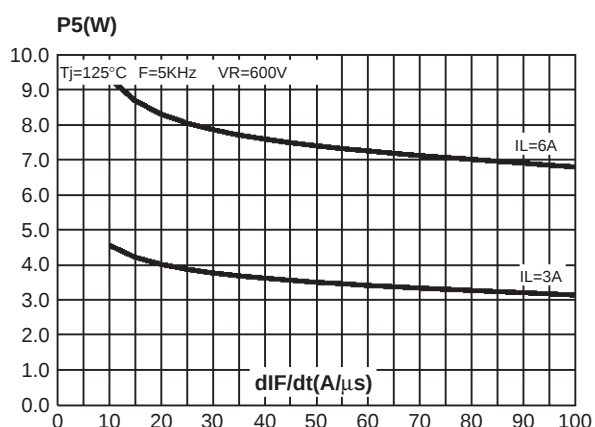


Fig. 14: Relative variation of thermal impedance junction to case versus pulse duration.

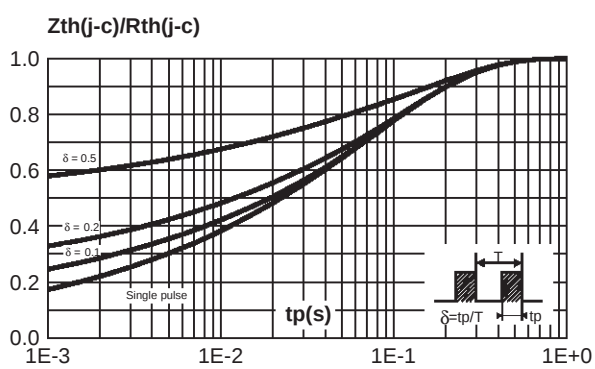


Fig. 15: Peak reverse recovery current versus dI_F/dt (90% confidence).

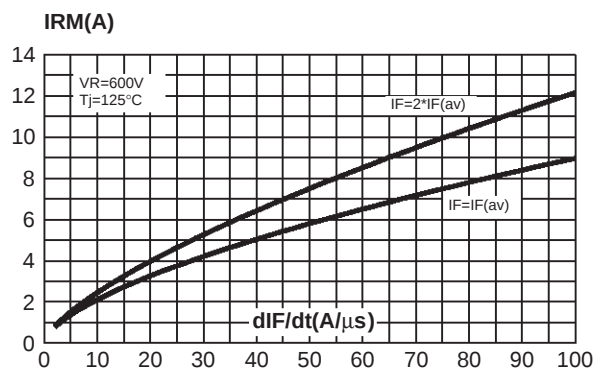


Fig. 16: Reverse recovery time versus dI_F/dt (90% confidence).

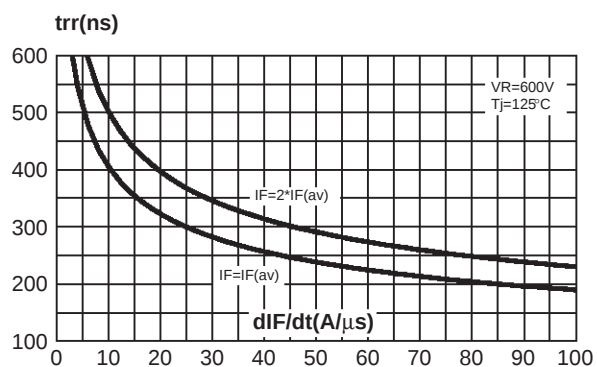


Fig. 17: Softness factor t_b/t_a versus dI_F/dt (typical values).

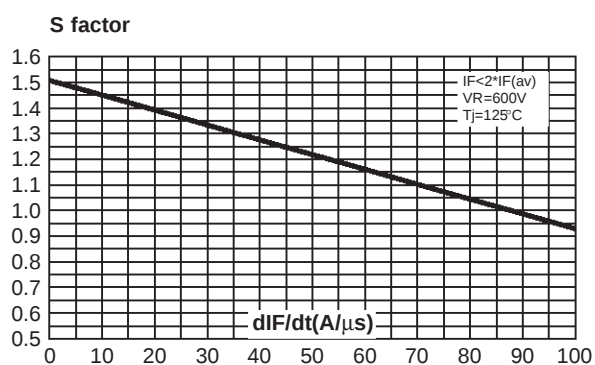


Fig. 18: Relative variation of dynamic parameters versus junction temperature (reference: $T_j=125^\circ\text{C}$).

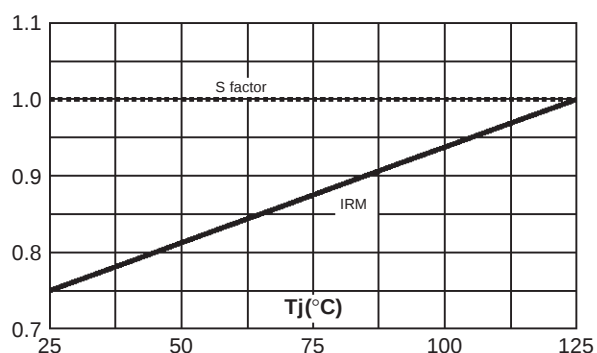


Fig. 19: Transient peak forward voltage versus dI_F/dt (90% confidence).

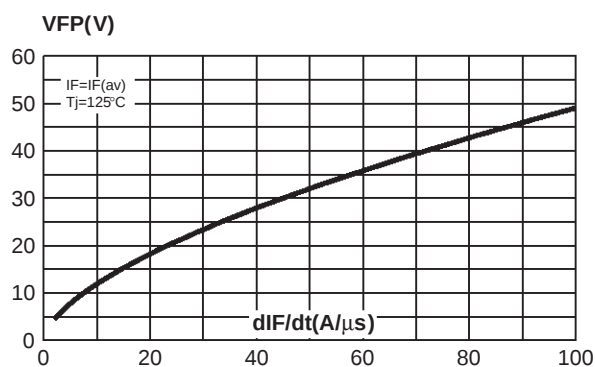
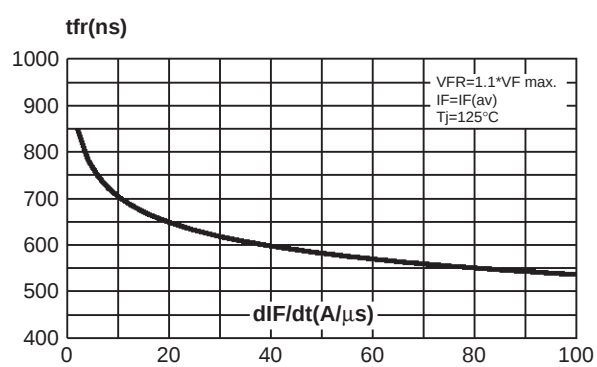
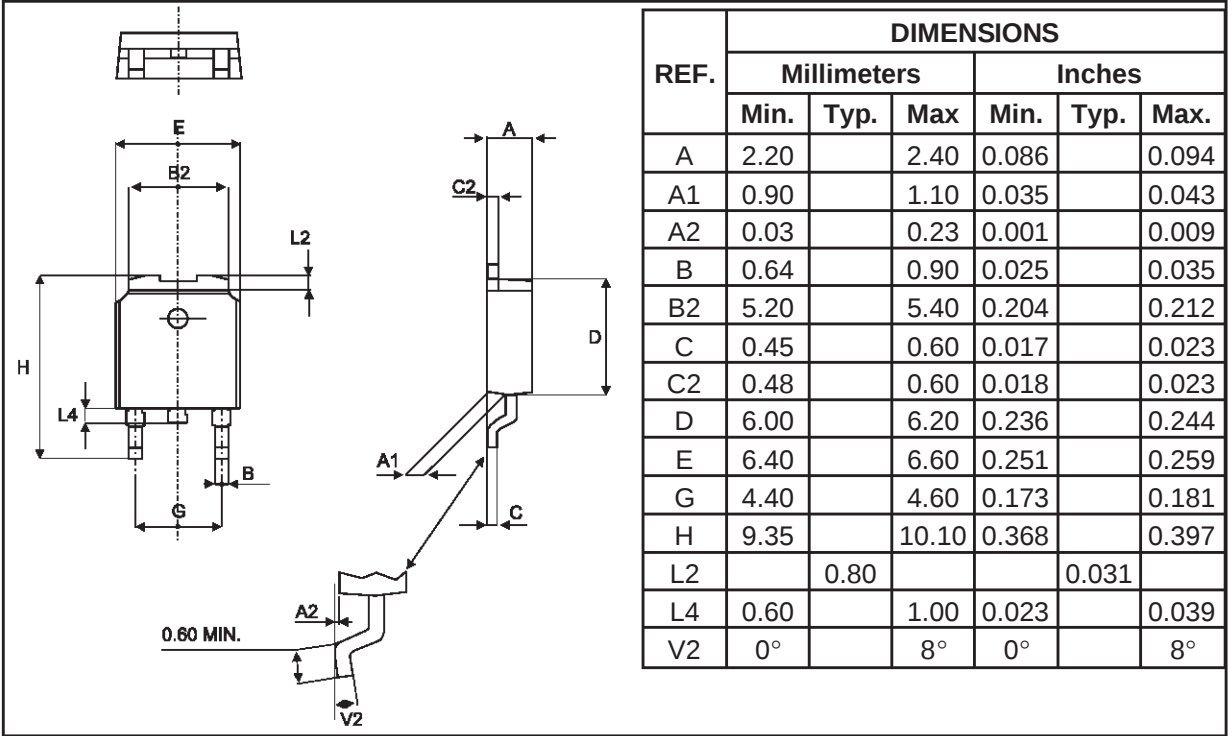


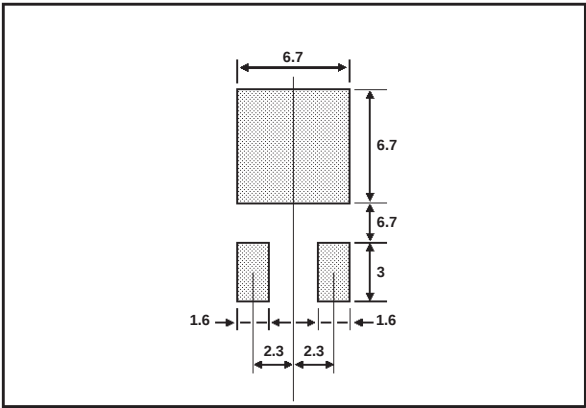
Fig. 20: Forward recovery time versus dI_F/dt (90% confidence).



PACKAGE MECHANICAL DATA
DPAK



FOOTPRINT DIMENSIONS (in millimeters)
DPAK



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